

## Sonic-FRD

High Performance Fast Recovery Diode  
 Low Loss and Soft Recovery  
 Single Diode

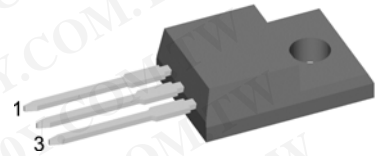
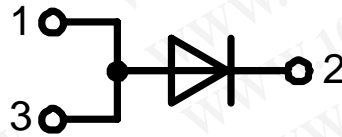
$$V_{RRM} = 600 \text{ V}$$

$$I_{FAV} = 15 \text{ A}$$

$$t_{rr} = 35 \text{ ns}$$

Part number (Marking on product)

DHF 30 IM 600PN



### Features / Advantages:

- Planar passivated chips
- Very low leakage current
- Very short recovery time
- Improved thermal behaviour
- Very low  $I_{RM}$ -values
- Very soft recovery behaviour
- Avalanche voltage rated for reliable operation
- Soft reverse recovery for low EMI/RFI
- Low  $I_{RM}$  reduces:
  - Power dissipation within the diode
  - Turn-on loss in the commutating switch

### Applications:

- Antiparallel diode for high frequency switching devices
- Antisaturation diode
- Snubber diode
- Free wheeling diode
- Rectifiers in switch mode power supplies (SMPS)
- Uninterruptible power supplies (UPS)

### Package:

- TO-220FPAB
- Industry standard outline
  - Plastic overmolded tab for electrical isolation
  - Epoxy meets UL 94V-0
  - RoHS compliant

### Ratings

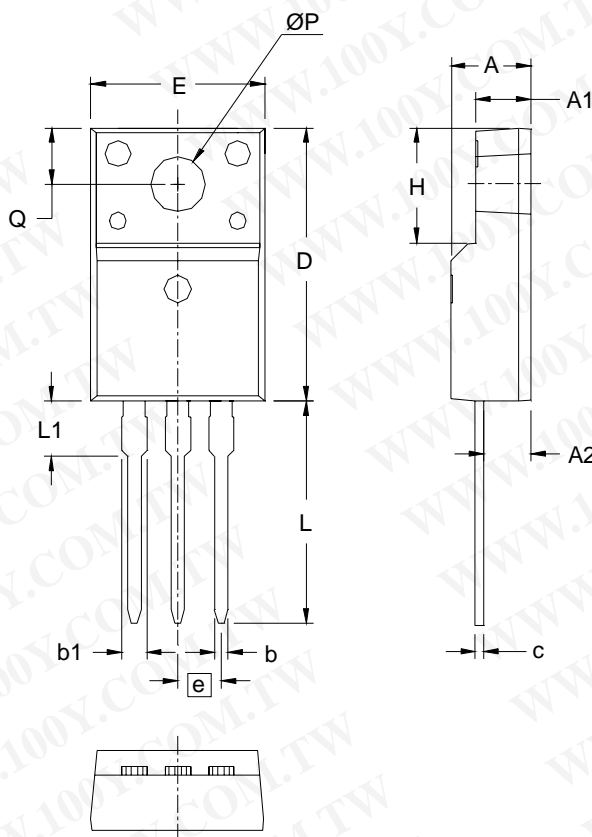
Symbol	Definition	Conditions	min. typ. max.			Unit
$V_{RRM}$	max. repetitive reverse voltage	$T_{VJ} = 25 \text{ }^\circ\text{C}$			600	V
$I_R$	reverse current	$V_R = 600 \text{ V}$			50	$\mu\text{A}$
		$V_R = 600 \text{ V}$			5	mA
$V_F$	forward voltage	$I_F = 30 \text{ A}$			2.37	V
		$I_F = 60 \text{ A}$			3.18	V
		$I_F = 30 \text{ A}$			2.22	V
		$I_F = 60 \text{ A}$			3.11	V
$I_{FAV}$	average forward current	rectangular, $d = 0.5$			15	A
$V_{FO}$	threshold voltage	} for power loss calculation only			1.31	V
$r_F$	slope resistance				29.2	m $\Omega$
$R_{thJC}$	thermal resistance junction to case				3.50	K/W
$T_{VJ}$	virtual junction temperature		-55		150	$^\circ\text{C}$
$P_{tot}$	total power dissipation	$T_C = 25 \text{ }^\circ\text{C}$			35	W
$I_{FSM}$	max. forward surge current	$t_p = 10 \text{ ms (50 Hz), sine}$			200	A
$I_{RM}$	max. reverse recovery current	$I_F = 30 \text{ A};$		12		A
		$-di_F/dt = 600 \text{ A}/\mu\text{s}$				A
$t_{rr}$	reverse recovery time	$V_R = 400 \text{ V}$		35		ns
						ns
$C_J$	junction capacitance	$V_R = 300 \text{ V}; f = 1 \text{ MHz}$		40		pF
$E_{AS}$	non-repetitive avalanche energy	$I_{AS} = 2 \text{ A}; L = 100 \mu\text{H}$			0.5	mJ
$I_{AR}$	repetitive avalanche current	$V_A = 1.5 \cdot V_R$ typ.; $f = 10 \text{ kHz}$			0.9	A

Symbol	Definition	Conditions	Ratings			Unit
			min.	typ.	max.	
$I_{RMS}$	RMS current	per pin*			35	A
$R_{thCH}$	thermal resistance case to heatsink			0.50		K/W
$M_D$	mounting torque		0.4		0.6	Nm
$F_C$	mounting force with clip		20		60	N
$T_{stg}$	storage temperature		-55		150	°C
<b>Weight</b>				2		g

\* Irms is typically limited by: 1. pin-to-chip resistance; or by 2. current capability of the chip.

In case of 1, a common cathode/anode configuration and a non-isolated backside, the whole current capability can be used by connecting the backside.

### Outlines TO-220FPAB



SYM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.177	.193	4.50	4.90
A1	.092	.108	2.34	2.74
A2	.101	.117	2.56	2.96
b	.028	.035	0.70	0.90
b1	.050	.058	1.27	1.47
c	.018	.024	0.45	0.60
D	.617	.633	15.67	16.07
E	.392	.408	9.96	10.36
e	.100 BSC		2.54 BSC	
H	.255	.271	6.48	6.88
L	.499	.523	12.68	13.28
L1	.119	.135	3.03	3.43
ØP	.121	.129	3.08	3.28
Q	.126	.134	3.20	3.40

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